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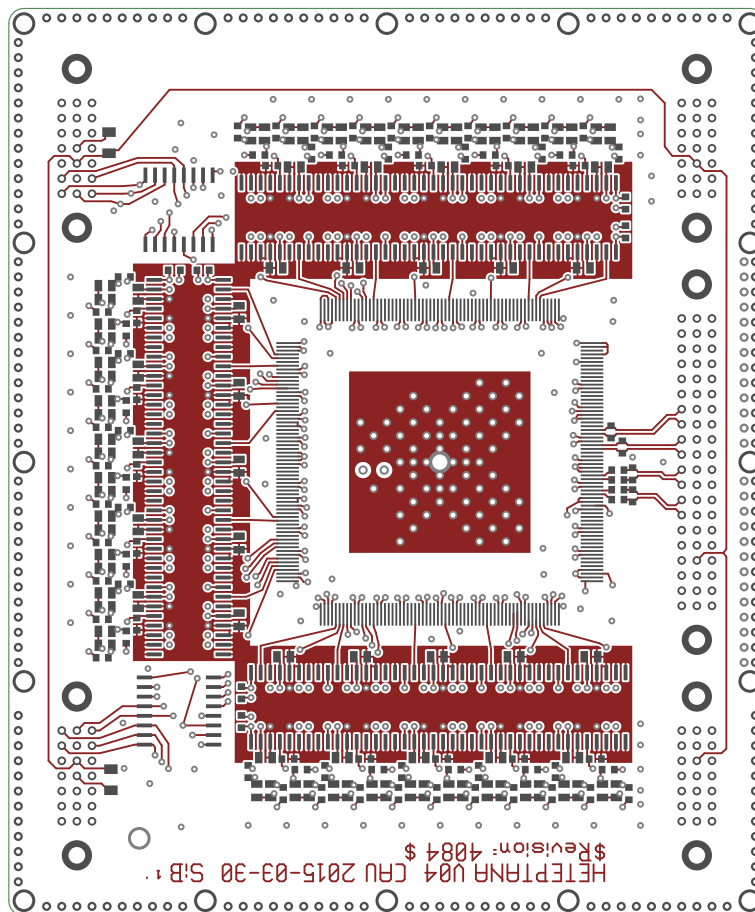
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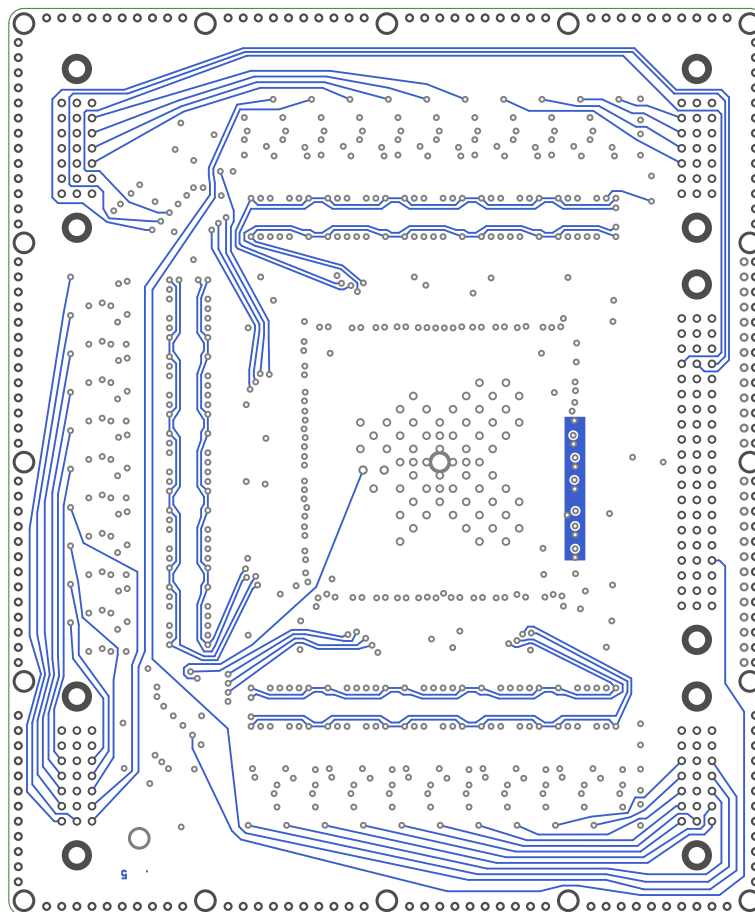
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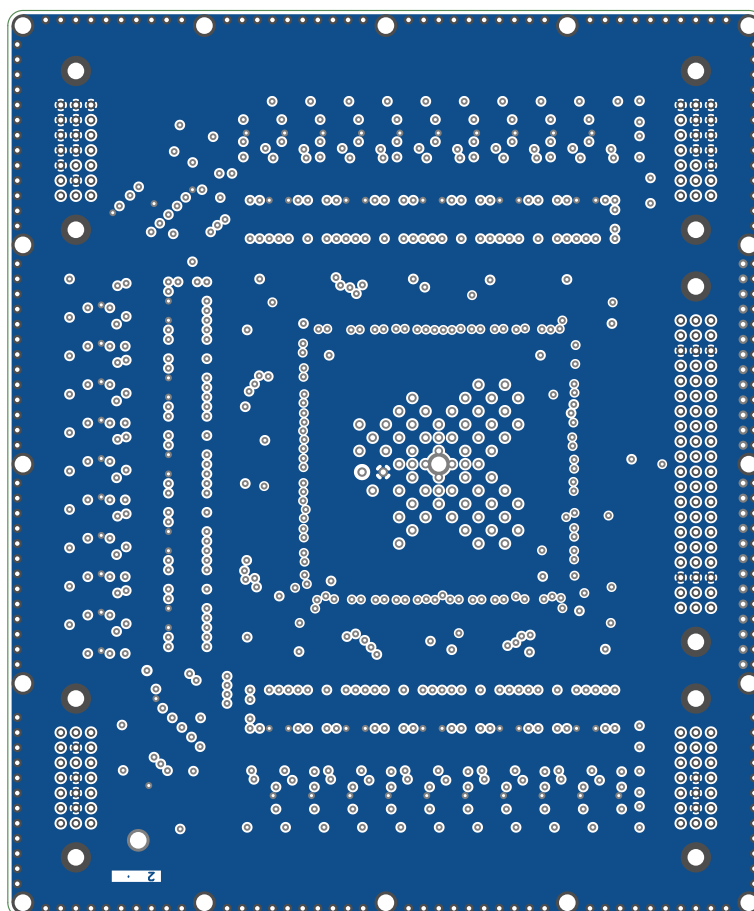
16. topassembly

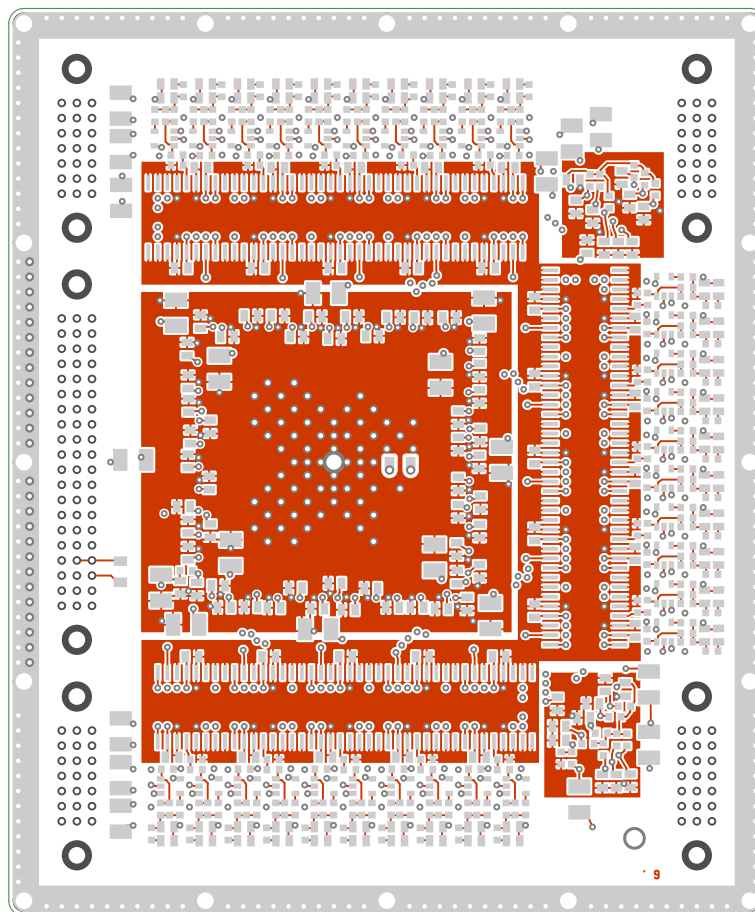
../heptana-actel.pcb
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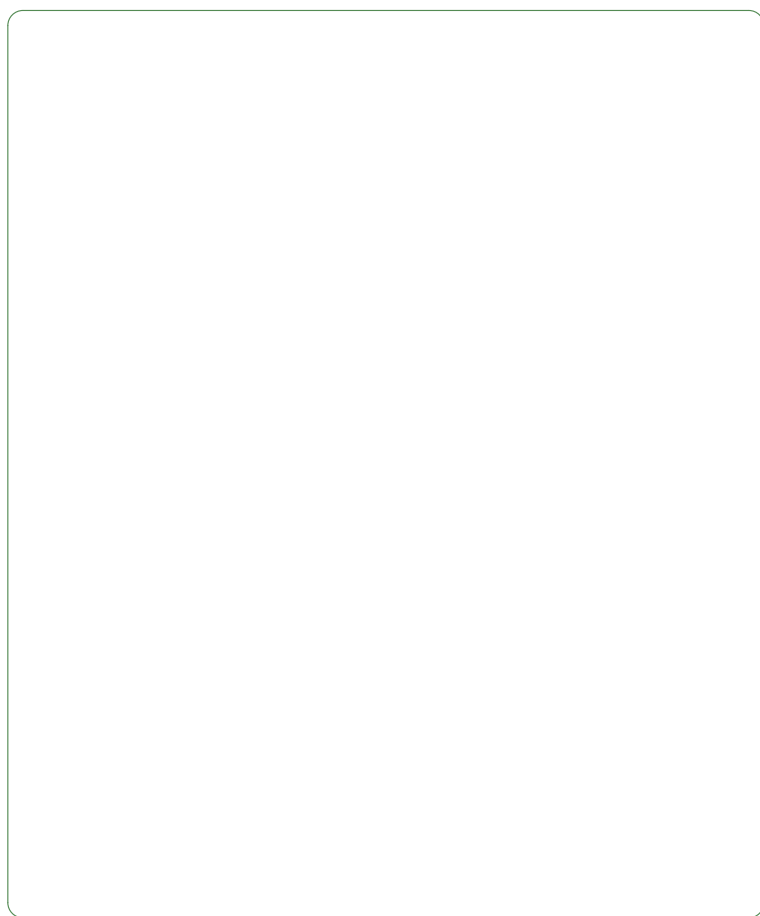
18. f.l

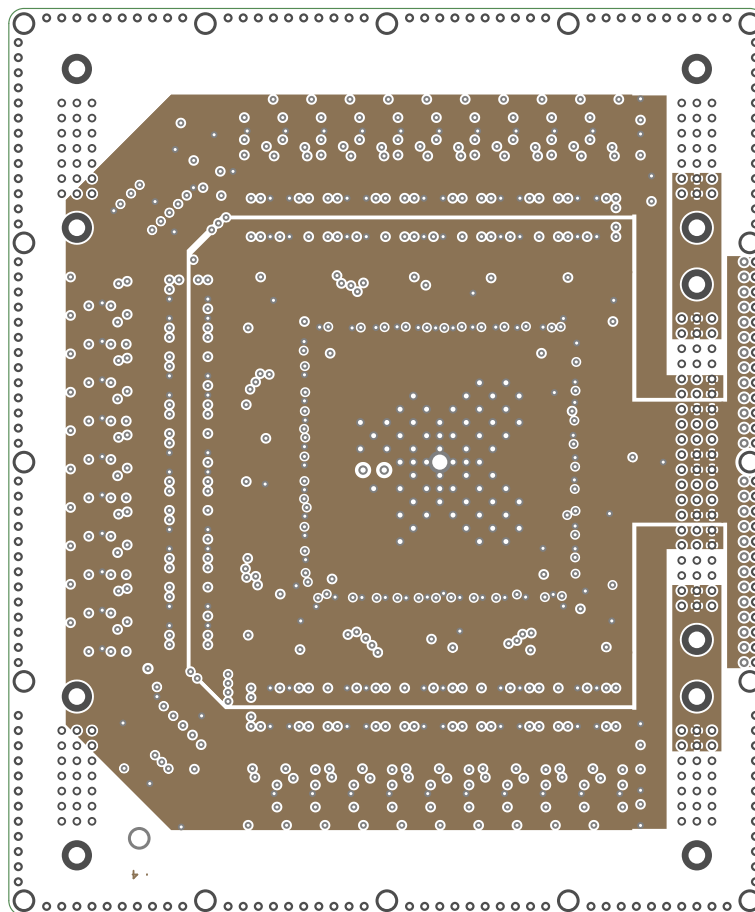


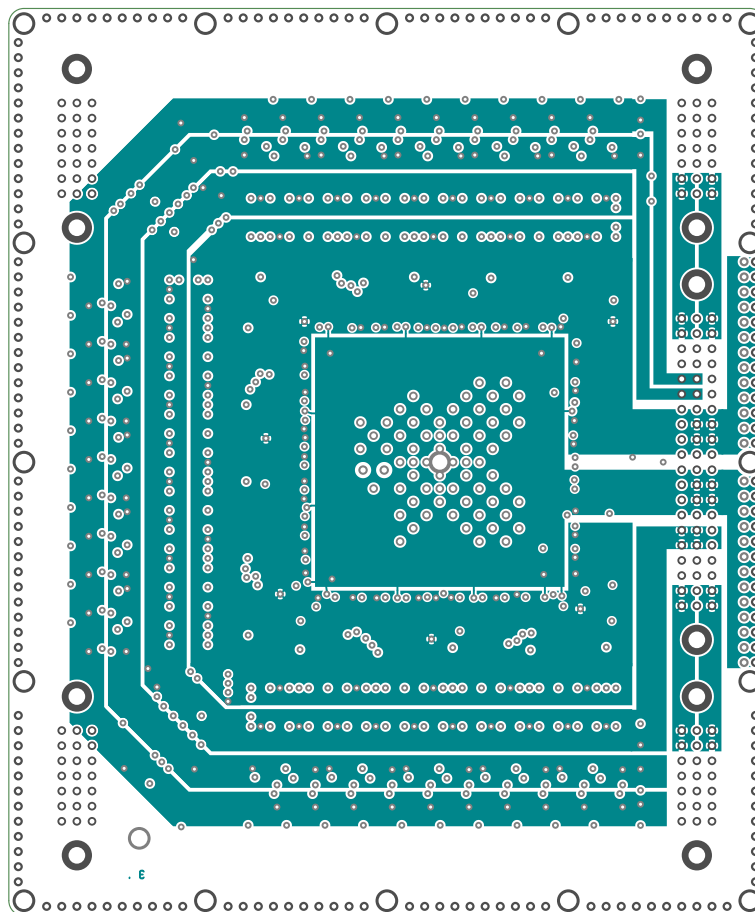


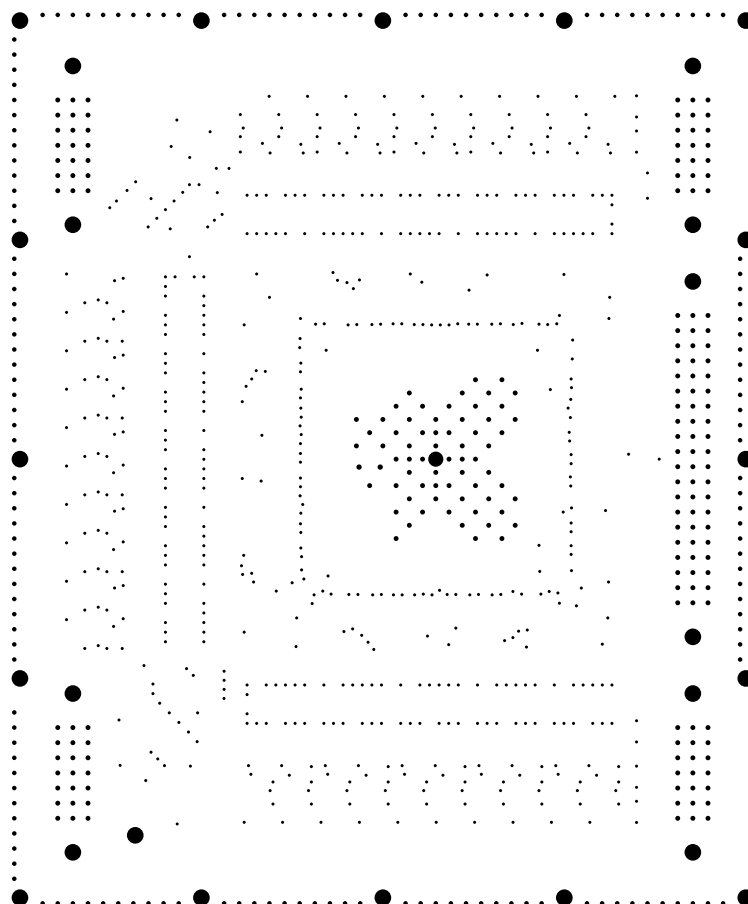


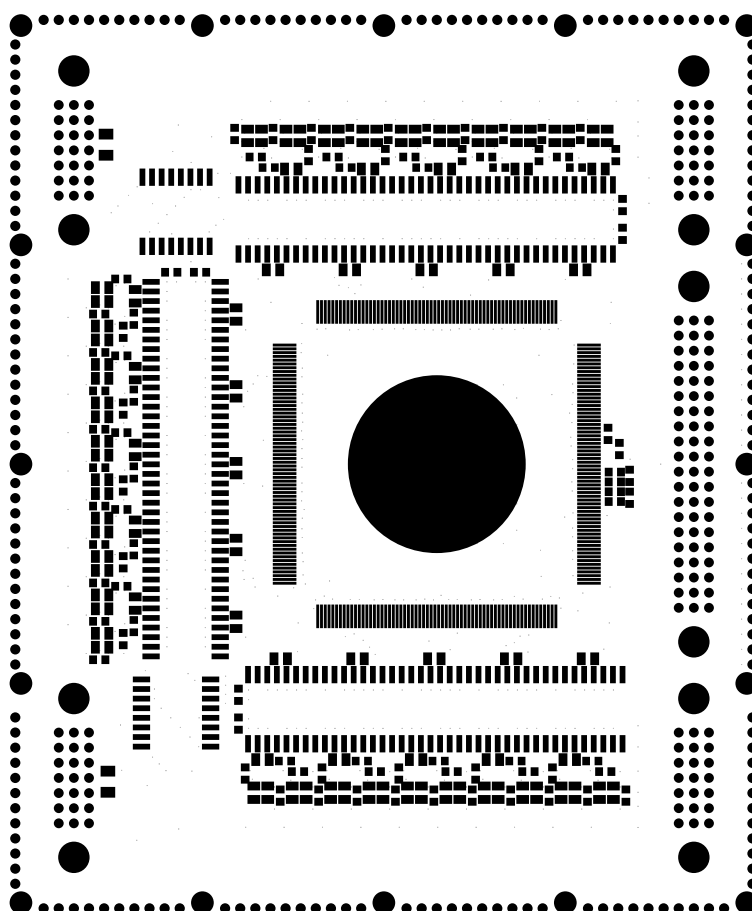


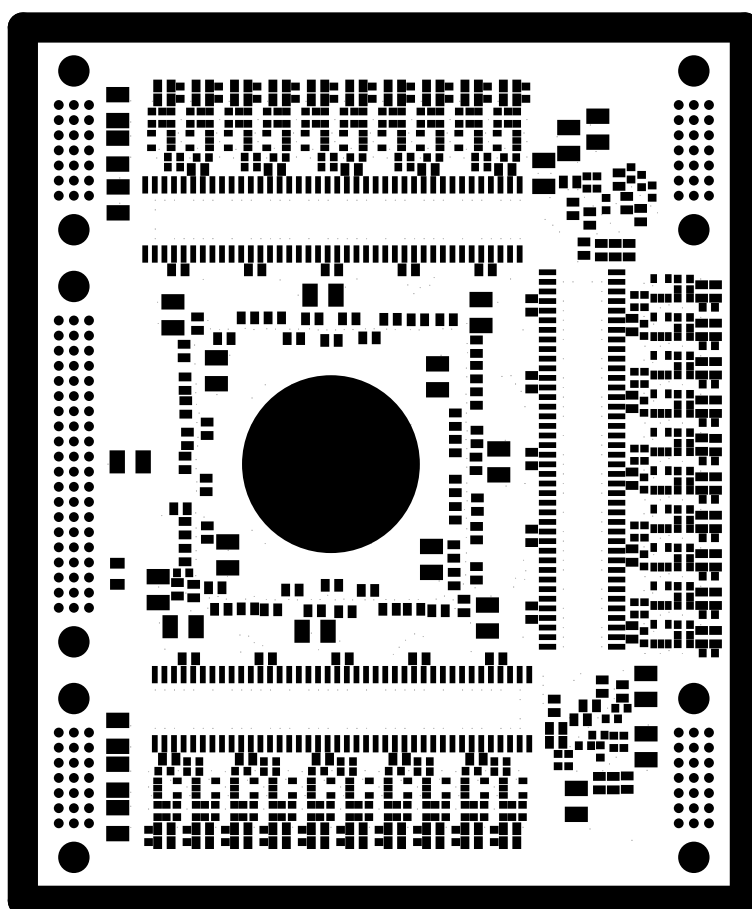


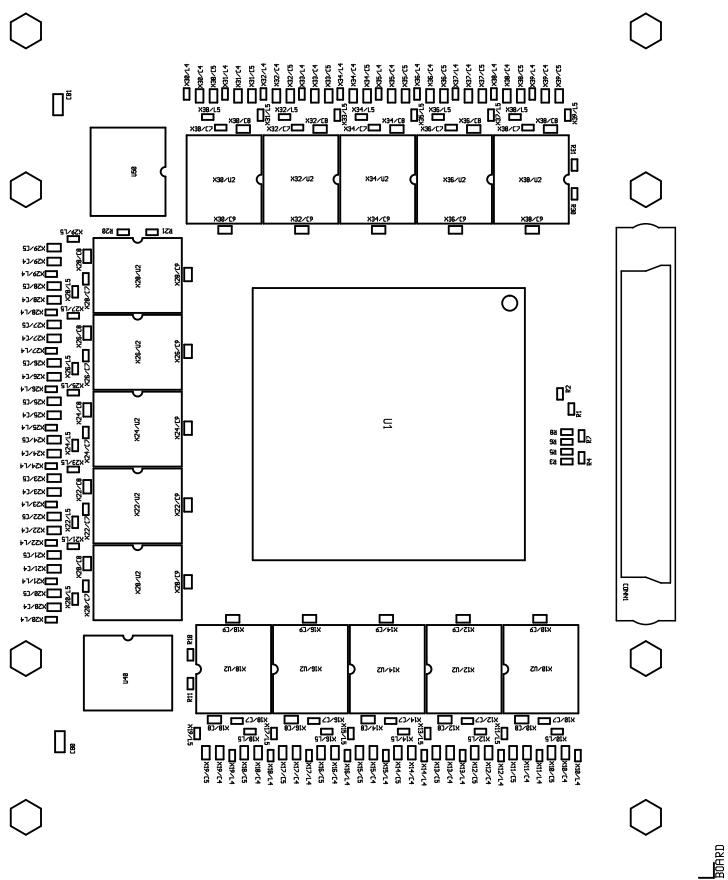


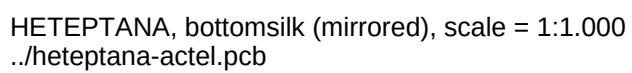


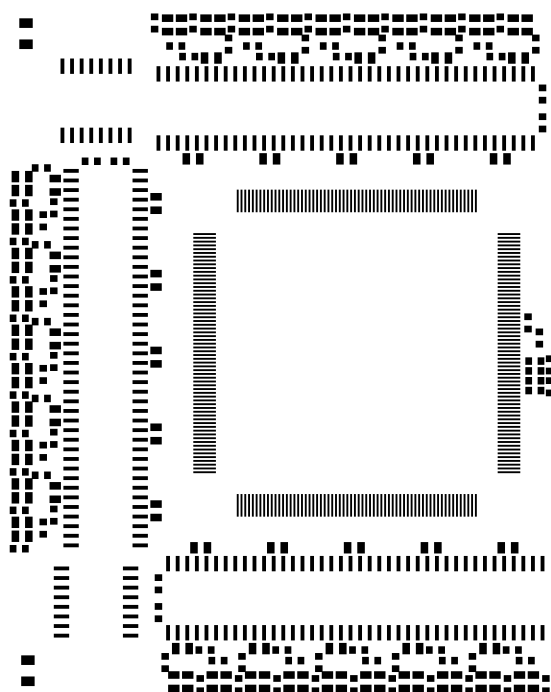


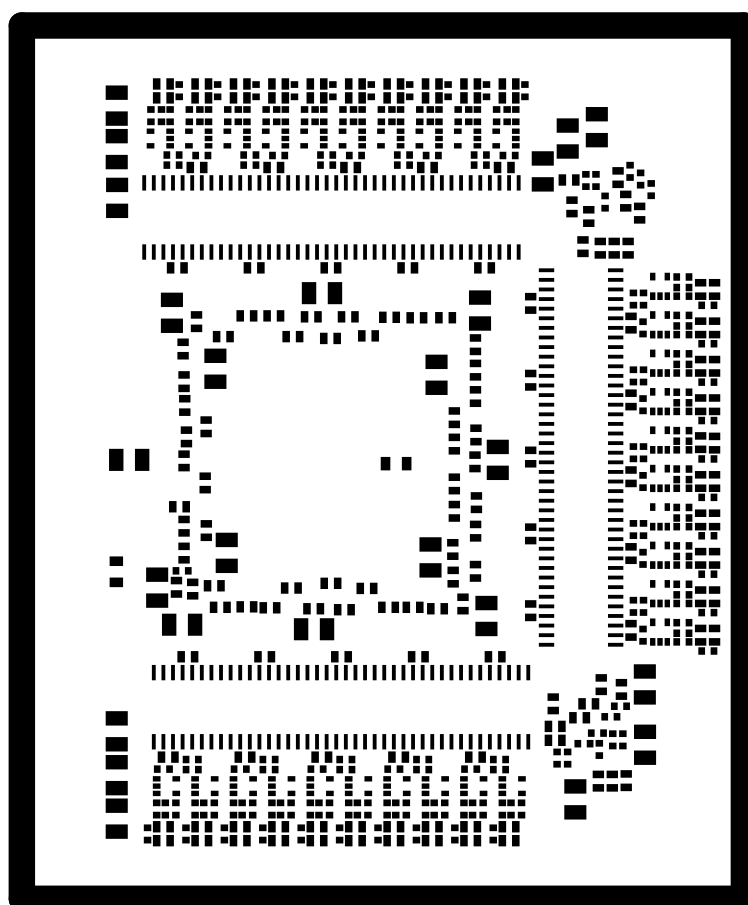


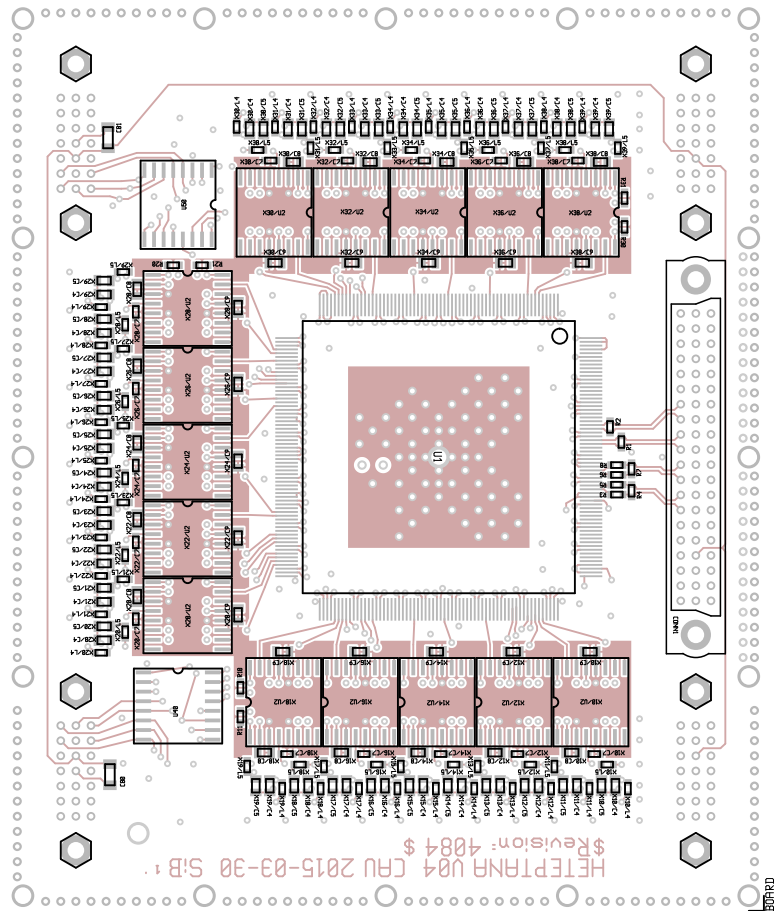


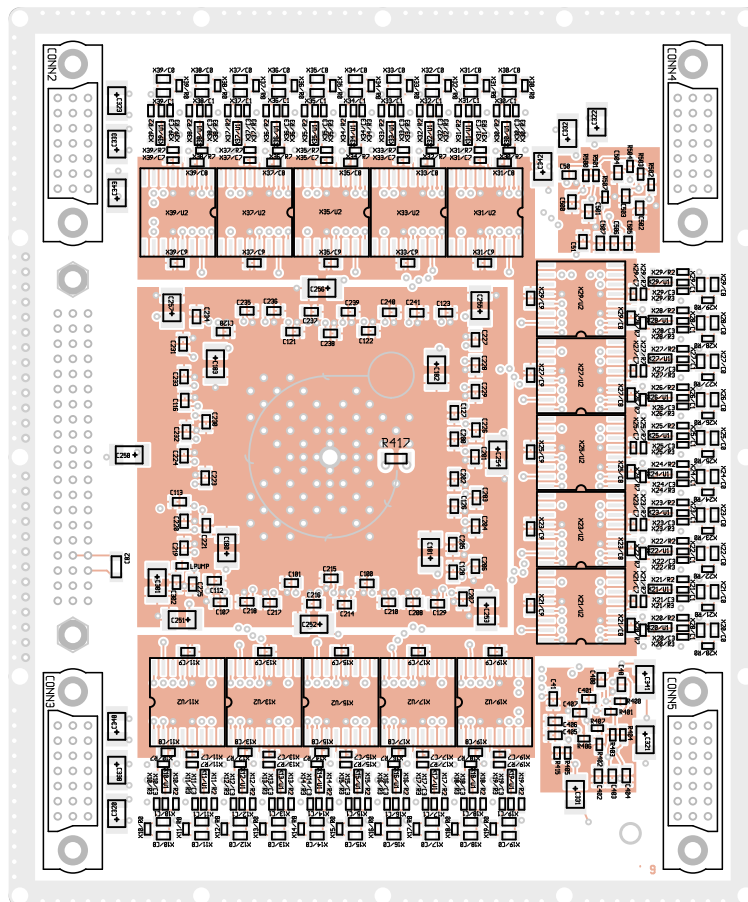








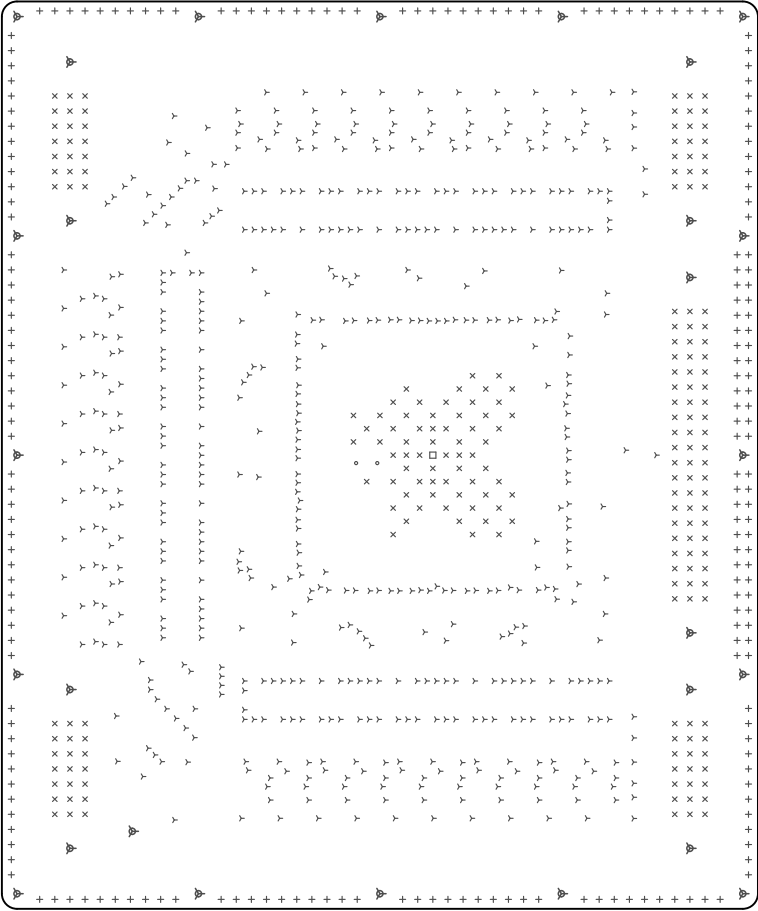




There are 6 different drill sizes used in this layout, 1042 holes total

Symbol	Diam. (Inch)	Count	Plated?
γ	0.016	595	YES
+	0.024	208	YES
x	0.026	209	YES
o	0.028	2	YES
□	0.079	1	YES
▽	0.087	27	YES

Title: HETEPTANA - Fabrication Drawing
Author: Stephan Boettcher
Date: Mo 30 ■■■ - 2015 16:53:18 GMT UTC



Board outline is the centerline of this path